Matched N-Channel JFET Pairs

PRODUCT SUMMARY					
Part Number	**$V_{GS(off)}$ (V)**	**$V_{(BR)GSS}$ Min (V)**	**g_{fs} Min (mS)**	**I_G Typ (pA)**	**$\|V_{GS1} - V_{GS2}\|$ Max (mV)**
2N5564	–0.5 to –3	–40	7.5	–3	5
2N5565	–0.5 to –3	–40	7.5	–3	10
2N5566	–0.5 to –3	–40	7.5	–3	20

FEATURES

- Two-Chip Design
- High Slew Rate
- Low Offset/Drift Voltage
- Low Gate Leakage: 3 pA
- Low Noise: 12 nV/√Hz @ 10 Hz
- Good CMRR: 76 dB
- Minimum Parasitics

BENEFITS

- Tight Differential Match vs. Current
- Improved Op Amp Speed, Settling Time Accuracy
- Minimum Input Error/Trimming Requirement
- Insignificant Signal Loss/Error Voltage
- High System Sensitivity
- Minimum Error with Large Input Signals
- Maximum High Frequency Performance

APPLICATIONS

- Wideband Differential Amps
- High-Speed, Temp-Compensated, Single-Ended Input Amps
- High-Speed Comparators
- Impedance Converters
- Matched Switches

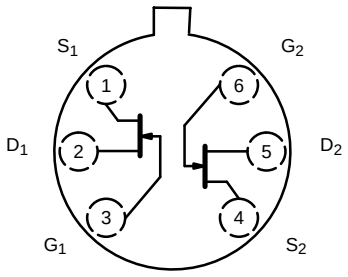
DESCRIPTION

The 2N5564/5565/5566 are matched pairs of JFETs mounted in a TO-71 package. This two-chip design reduces parasitics for good performance at high frequency while ensuring extremely tight matching. This series features high breakdown voltage ($V_{(BR)DSS}$ typically > 55 V), high gain (typically > 9 mS), and <5 mV offset between the two die.

The hermetically-sealed TO-71 package is available with full military processing (see Military Information).

For similar products see the low-noise U/SST401 series, and the low-leakage 2N5196/5197/5198/5199 data sheets.

TO-71



Top View

ABSOLUTE MAXIMUM RATINGS

Gate-Drain, Gate-Source Voltage . . . . . –40 V
Gate-Gate Voltage . . . . . ±80 V
Gate Current . . . . . 50 mA
Lead Temperature ($^1/_{16}$" from case for 10 sec.) . . . . . 300 °C
Storage Temperature . . . . . –65 to 200°C

Operating Junction Temperature . . . . . –55 to 150°C
Power Dissipation : Per Side[a] . . . . . 325 mW
Total[b] . . . . . 650 mW

Notes
a. Derate 2.6 mW/°C above 25°C
b. Derate 5.2 mW/°C above 25°C

SPECIFICATIONS (T_A = 25°C UNLESS OTHERWISE NOTED)

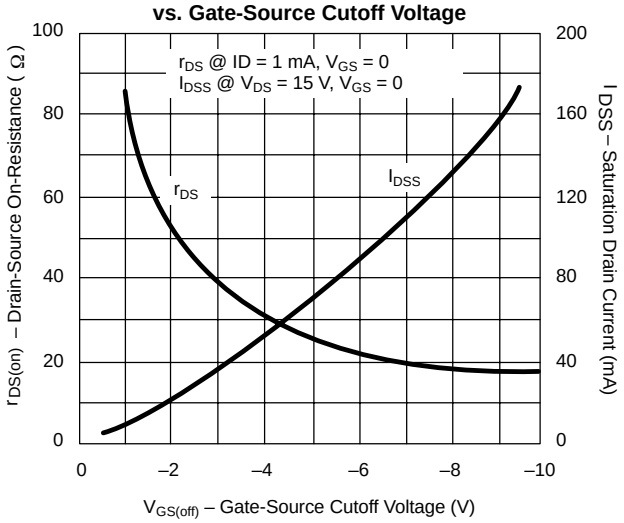
Parameter	Symbol	Test Conditions	Typ[a]	Limits 2N5564 Min	2N5564 Max	2N5565 Min	2N5565 Max	2N5566 Min	2N5566 Max	Unit
Static										
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	I_G = –1 µA, V_{DS} = 0 V	–55	–40		–40		–40		V
Gate-Source Cutoff Voltage	$V_{GS(off)}$	V_{DS} = 15 V, I_D = 1 nA	–2	–0.5	–3	–0.5	–3	–0.5	–3	V
Saturation Drain Current[b]	I_{DSS}	V_{DS} = 15 V, V_{GS} = 0 V	20	5	30	5	30	5	30	mA
Gate Reverse Current	I_{GSS}	V_{GS} = –20 V, V_{DS} = 0 V	–5		–100		–100		–100	pA
		T_A = 150°C	–10		–200		–200		–200	nA
Gate Operating Current[c]	I_G	V_{DG} = 15 V, I_D = 2 mA	–3							pA
		T_A = 125°C	–1							nA
Drain-Source On-Resistance	$r_{DS(on)}$	V_{GS} = 0 V, I_D = 1 mA	50		100		100		100	Ω
Gate-Source Voltage[c]	V_{GS}	V_{DG} = 15 V, I_D = 2 mA	–1.2							V
Gate-Source Forward Voltage	$V_{GS(F)}$	I_G = 2 mA , V_{DS} = 0 V	0.7		1		1		1	V
Dynamic										
Common-Source Forward Transconductance	g_{fs}	V_{DS} = 15 V, I_D = 2 mA f = 1 kHz	9	7.5	12.5	7.5	12.5	7.5	12.5	mS
Common-Source Output Conductance	g_{os}		35		45		45		45	µS
Common-Source Forward Transconductance	g_{fs}	V_{DS} = 15 V, I_D = 2 mA f = 100 MHz	8.5	7		7		7		mS
Common-Source Input Capacitance	C_{iss}	V_{DS} = 15 V, I_D = 2 mA f = 1 MHz	10		12		12		12	pF
Common-Source Reverse Transfer Capacitance	C_{rss}		2.5		3		3		3	pF
Equivalent Input Noise Voltage	$\overline{e}_n$	V_{DS} = 15 V, I_D = 2 mA f = 10 Hz	12		50		50		50	$\frac{nV}{\sqrt{Hz}}$
Noise Figure	NF	R_G = 10 MΩ			1		1		1	dB
Matching										
Differential Gate-Source Voltage	$\lvert V_{GS1}-V_{GS2}\rvert$	V_{DG} = 15 V, I_D = 2 mA			5		10		20	mV
Gate-Source Voltage Differential Change with Temperature	$\frac{\Delta\lvert V_{GS1}-V_{GS2}\rvert}{\Delta T}$	V_{DG} = 15 V, I_D = 2 mA T_A = –55 to 125°C			10		25		50	$\frac{\mu V}{°C}$
Saturation Drain Current Ratio[c]	$\frac{I_{DSS1}}{I_{DSS2}}$	V_{DS} = 15 V, V_{GS} = 0 V	0.98	0.95	1	0.95	1	0.95	1	
Transconductance Ratio	$\frac{g_{fs1}}{g_{fs2}}$	V_{DS} = 15 V, I_D = 2 mA f = 1 kHz	0.98	0.95	1	0.90	1	0.90	1	
Common Mode Rejection Ratio[c]	CMRR	V_{DG} = 10 to 20 V I_D = 2 mA	76							dB

Notes
a. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
b. Pulse test: PW ≤ 300 µs duty cycle ≤ 3%.
c. This parameter not registered with JEDEC.

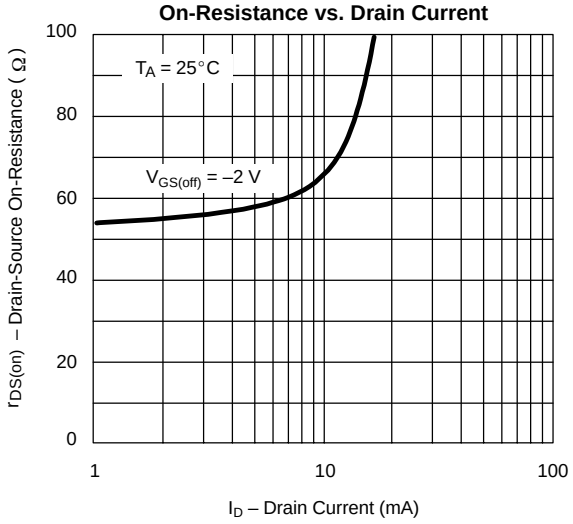
NCBD

TYPICAL CHARACTERISTICS (T_A = 25°C UNLESS OTHERWISE NOTED)

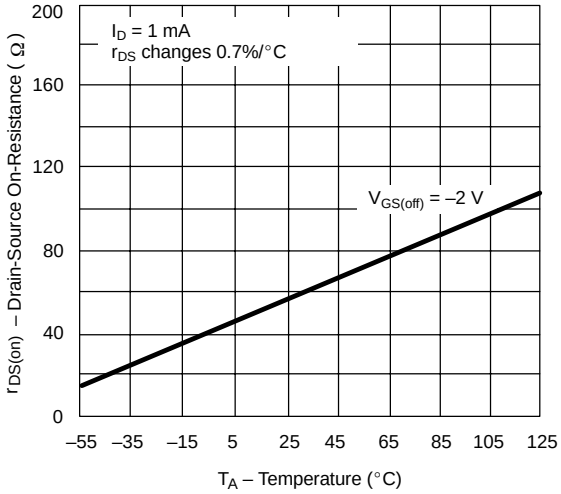
On-Resistance and Drain Current vs. Gate-Source Cutoff Voltage



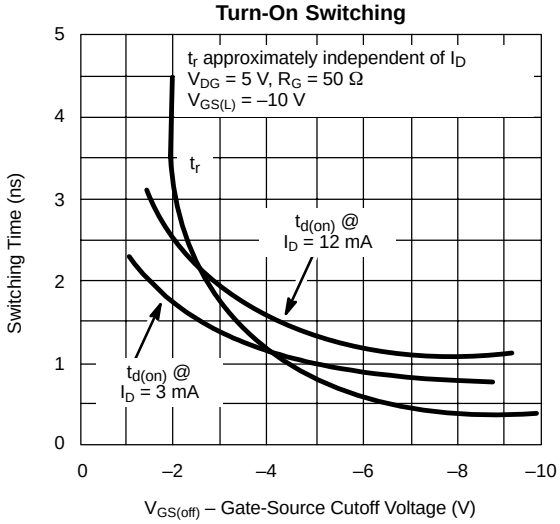
On-Resistance vs. Drain Current



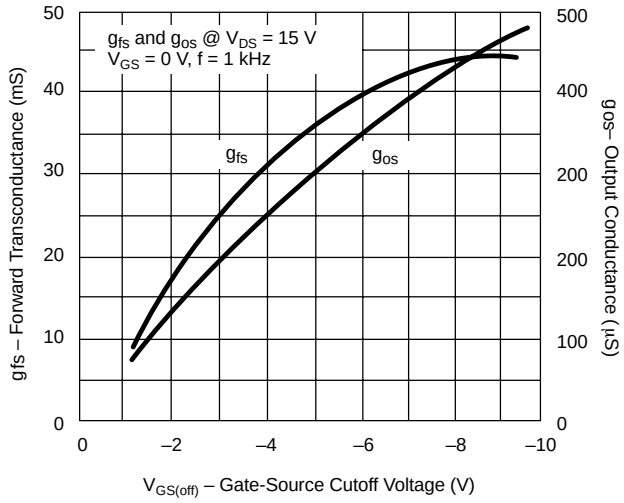
On-Resistance vs. Temperature



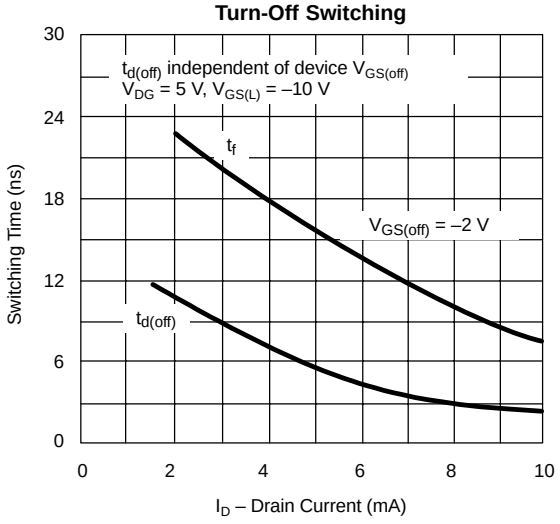
Turn-On Switching



Forward Transconductance and Output Conductance vs. Gate-Source Cutoff Voltage

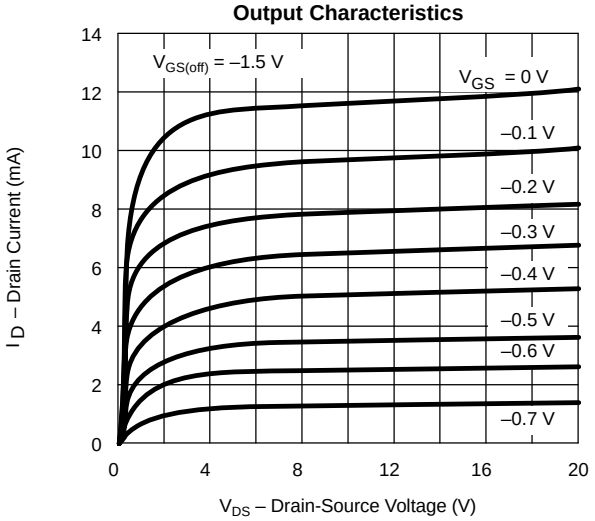


Turn-Off Switching

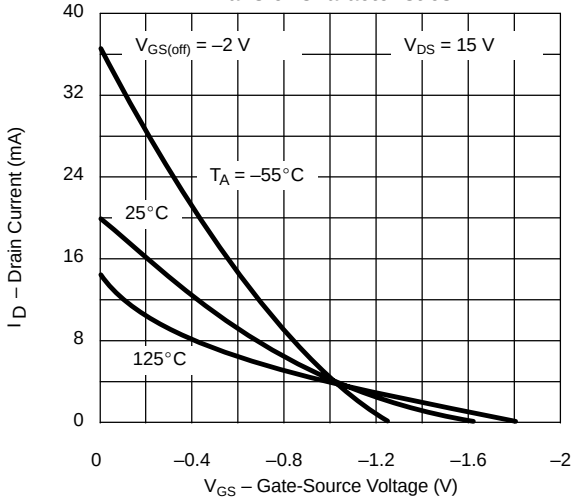


TYPICAL CHARACTERISTICS (T_A = 25°C UNLESS OTHERWISE NOTED)

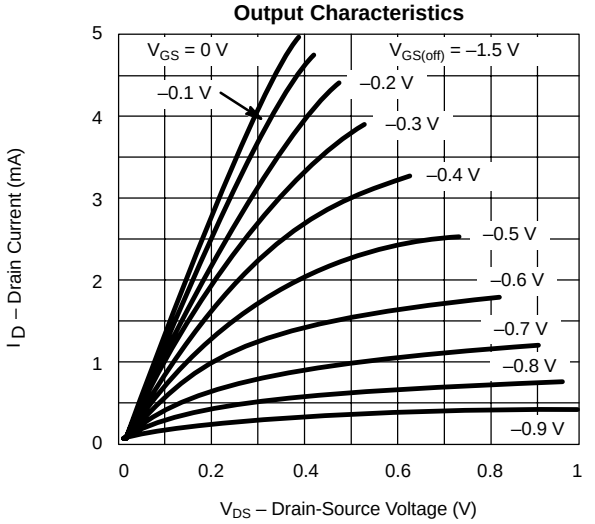
Output Characteristics



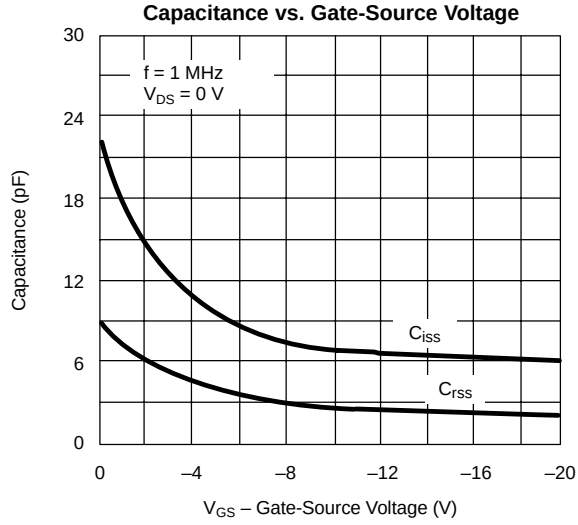
Transfer Characteristics



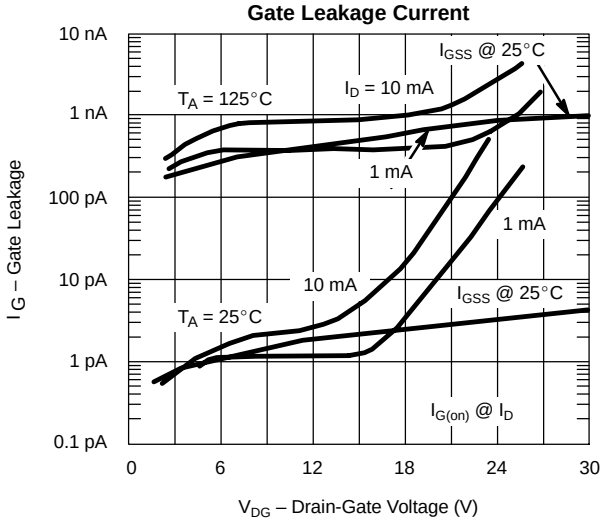
Output Characteristics



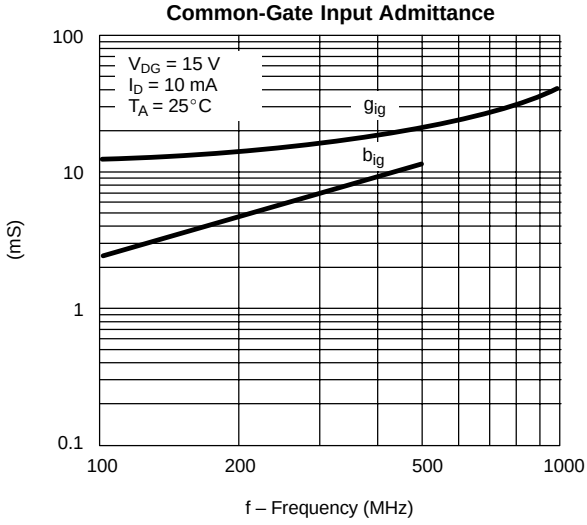
Capacitance vs. Gate-Source Voltage



Gate Leakage Current



Common-Gate Input Admittance



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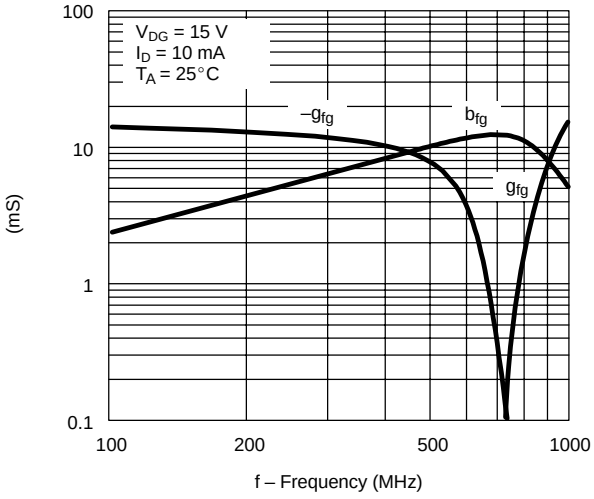
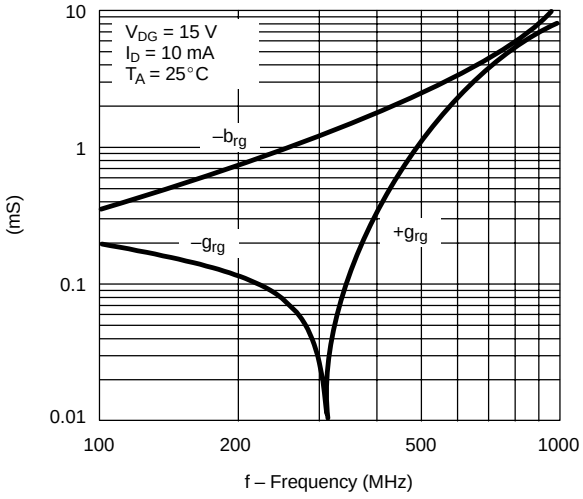
TYPICAL CHARACTERISTICS (T_A = 25°C UNLESS OTHERWISE NOTED)

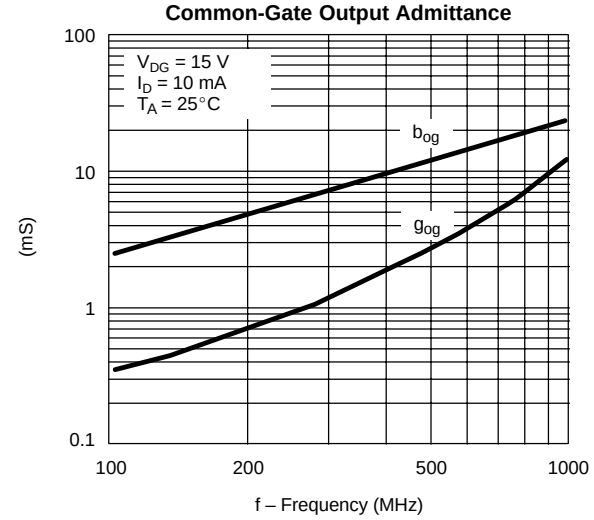
Common-Gate Forward Admittance



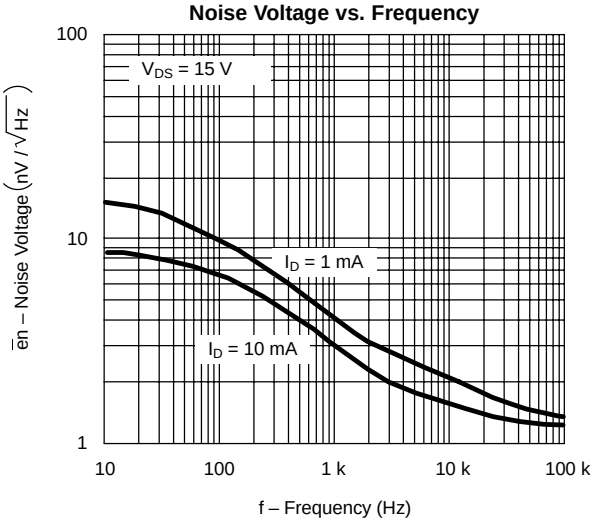
Common-Gate Reverse Admittance



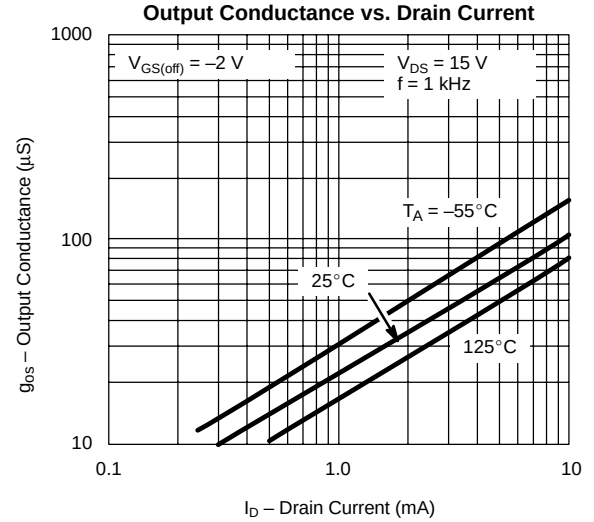
Common-Gate Output Admittance



Noise Voltage vs. Frequency



Output Conductance vs. Drain Current



Transconductance vs. Drain Current